

E010 | EXPERIMENTAL BOARD, PERFORATED

Experimental board in euro measurement.

Technical Data:

Without copper layer | **Material:** FR2 (Pertinax) | **Hole distance:** 2,54 mm | **Diameter of holes:** Ø approx. 1 mm | **Thickness:** approx. 1,5 mm | **Dimensions:** approx. 100 x 160 mm

E011 | EXPERIMENTAL BOARD STRIP GRID

Flash-gold plated (better for soldering „leadfree“).

Technical Data:

One-side copper layer: approx. 35 µm | **Material:** FR2 (Pertinax) | **Hole distance:** 2,54 mm | **Diameter of holes:** Ø approx. 1 mm | **Thickness:** approx. 1,5 mm | **Dimensions:** approx. 100 x 500 mm

E012 | EXPERIMENTAL BOARD STRIP GRID

Flash-gold plated (better for soldering „leadfree“).

Technical Data:

One-side copper layer: approx. 35 µm | **Material:** FR2 (Pertinax) | **Hole distance:** 2,54 mm | **Diameter of holes:** Ø approx. 1 mm | **Thickness:** approx. 1,5 mm | **Dimensions:** approx. 100 x 100 mm

E013 | EXPERIMENTAL BOARD with 3 STRIP GRID

The strip raster is interrupted every 3rd hole, flash-gold plated (better for soldering „leadfree“).

Technical Data:

One-side copper layer: approx. 35 µm | **Material:** FR2 (Pertinax) | **Hole distance:** 2,54 mm | **Diameter of holes:** Ø approx. 1 mm | **Thickness:** approx. 1,5 mm | **Dimensions:** approx. 100 x 160 mm

F001 | PHOTOPOSITIVE COATED BOARD

Photopositive coated board for production of printed circuits for electronics.

Technical Data:

One-side copper layer: approx. 35 µm | **Material:** FR2 (Pertinax) | **Thickness:** approx. 1,5 mm | **Dimensions:** approx. 100 x 160 mm

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